

CD4066B-Q1 SCHS383 - APRIL 2011

## **CMOS QUAD BILATERAL SWITCH**

Check for Samples: CD4066B-Q1

### FEATURES

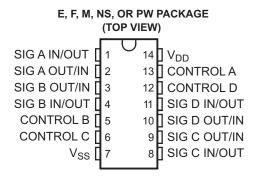
- Qualified for Automotive Applications
- 15-V Digital or ±7.5-V Peak-to-Peak Switching
- 125-Ω Typical On-State Resistance for 15-V Operation
- Switch On-State Resistance Matched to Within 5  $\Omega$  Over 15-V Signal-Input Range
- On-State Resistance Flat Over Full Peak-to-Peak Signal Range
- High On/Off Output-Voltage Ratio: 80 dB Typical at  $f_{is}$  = 10 kHz,  $R_L$  = 1 k $\Omega$
- High Degree of Linearity: <0.5% Distortion Typical at  $f_{is} = 1$  kHz,  $V_{is} = 5$  V p-p,  $V_{DD} - V_{SS} \ge 10$  V,  $R_L = 10$  k $\Omega$
- Extremely Low Off-State Switch Leakage, Resulting in Very Low Offset Current and High Effective Off-State Resistance: 10 pA Typical at  $V_{DD} - V_{SS} = 10$  V,  $T_A = 25^{\circ}$ C
- Extremely High Control Input Impedance (Control Circuit Isolated From Signal Circuit): 10<sup>12</sup> Ω Typical
- Low Crosstalk Between Switches: –50 dB Typical at  $f_{is}$  = 8 MHz,  $R_L$  = 1 k $\Omega$
- Matched Control-Input to Signal-Output Capacitance: Reduces Output Signal Transients
- Frequency Response, Switch On = 40 MHz Typical
- 100% Tested for Quiescent Current at 20 V

### **DESCRIPTION/ORDERING INFORMATION**

- 5-V, 10-V, and 15-V Parametric Ratings
- Latch-Up Exceeds 100mA per JESD78 Class I
- Meets All Requirements of JEDEC Tentative Standard No. 13-B, Standard Specifications for Description of "B" Series CMOS Devices

### **APPLICATIONS**

- Analog Signal Switching/Multiplexing: Signal Gating, Modulator, Squelch Control, Demodulator, Chopper, Commutating Switch
- Digital Signal Switching/Multiplexing
- Transmission-Gate Logic Implementation
- Analog-to-Digital and Digital-to-Analog Conversion
- Digital Control of Frequency, Impedance, Phase, and Analog-Signal Gain



The CD4066B-Q1 is a quad bilateral switch intended for the transmission or multiplexing of analog or digital signals. It is pin-for-pin compatible with the CD4016B, but exhibits a much lower on-state resistance. In addition, the on-state resistance is relatively constant over the full signal-input range.

The CD4066B-Q1 consists of four bilateral switches, each with independent controls. Both the p and the n devices in a given switch are biased on or off simultaneously by the control signal. As shown in Figure 1, the well of the n-channel device on each switch is tied to either the input (when the switch is on) or to VSS (when the switch is off). This configuration eliminates the variation of the switch-transistor threshold voltage with input signal and, thus, keeps the on-state resistance low over the full operating-signal range.

The advantages over single-channel switches include peak input-signal voltage swings equal to the full supply voltage and more constant on-state impedance over the input-signal range. However, for sample-and-hold applications, the CD4016B is recommended.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## CD4066B-Q1

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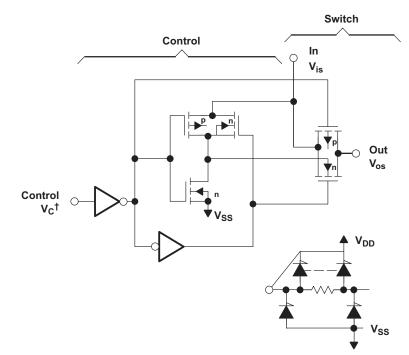
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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION									
T <sub>A</sub>	PAC	AGE	ORDERABLE PART NUMBER	TOP-SIDE MARKING					
–40°C to 125°C	SOIC – D	Reel of 2500	CD4066BQDRQ1	CD4066BQ					



<sup>†</sup> All control inputs are protected by the CMOS protection network.

- NOTES: A.All p substrates are connected to V <sub>DD</sub>. B. Normal operation control-line biasing: switch on (logic 1),  $V_C = V_{DD}$ ; switch off (logic 0),  $V_C = V_{SS}$ C. Signal-level range:  $V_{SS} \le V_{DD}$

Figure 1. Schematic Diagram of One-of-Four Identical Switches and Associated Control Circuitry



### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

		VALUE	UNIT
DC supply-voltage range, V <sub>DD</sub> (voltages	s referenced to V <sub>SS</sub> terminal)	-0.5 to 20	V
Input voltage range, V <sub>is</sub> (all inputs)	–0.5 to V <sub>DD</sub> + 0.5	V	
DC input current, IIN (any one input)	±10	mA	
Package thermal impedance, $\theta_{JA}^{(2)}$	86	°C/W	
	Human-Body Model (HBM)	500	
ESD Electrostatic discharge <sup>(3)</sup>	Machine Model (MM)	150	V
	Field_Induced_Charged Device Model (CDM)	1000	
Lead temperature (during soldering): At	265	°C	
Storage temperature range, T <sub>stg</sub>		-65 to 150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The package thermal impedance is calculated in accordance with JESD 51-7.

(3) Tested in accordance with AEC-Q100.

### THERMAL INFORMATION

		CD4066B-Q1		
	THERMAL METRIC <sup>(1)</sup>	D PACKAGE	UNITS	
		14 PINS		
$\theta_{JA}$	Junction-to-ambient thermal resistance	92.4		
θ <sub>JCtop</sub>	Junction-to-case (top) thermal resistance	52.5		
$\theta_{JB}$	Junction-to-board thermal resistance	46.7	°C/M	
$\Psi_{JT}$	Junction-to-top characterization parameter	46.4	°C/W	
$\Psi_{JB}$	Junction-to-board characterization parameter	46.4		
$\theta_{\text{JCbot}}$	Junction-to-case (bottom) thermal resistance	N/A		

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

### **RECOMMENDED OPERATING CONDITIONS**

		MIN	MAX	UNIT	
V <sub>DD</sub>	Supply voltage	3	18	V	
T <sub>A</sub>	Operating free-air temperature	-40	125	°C	

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### **ELECTRICAL CHARACTERISTICS**

over operating free-air temperature range (unless otherwise noted)

					LIMITS AT IN	IDICATED TEMP	ERATURE	S	
	PARAMETER	TEST CONDITIONS	V <sub>IN</sub>	V <sub>DD</sub>	–40°C	125°C	25	°C	UNIT
			(V)	(V)	40.0	.20 0	TYP	MAX	
			0.5	5	0.25	7.5	0.01	0.25	
I <sub>DD</sub>	Quiescent device current		0.10	10	0.5	15	0.01	0.5	μA
DD			0.15	15	1	30	0.01	1	μΛ
			0.20	20	5	150	0.02	5	
SIGN/	AL INPUTS (V <sub>is</sub> ) AND OUTPUT	TS (V <sub>os</sub> )							
		$V_{C} = V_{DD}$ , $R_{L} = 10 \text{ k}\Omega$ returned		5	850	1300	470	1050	
r <sub>on</sub>	On-state resistance (max)	V V		10	330	550	180	400	Ω
on		to $\frac{V_{DD} - V_{SS}}{V_{is} = V_{SS} c V_{DD}}$ ,	15	210	320	125	240		
	On-state resistance			5			15		
∆r <sub>on</sub>	difference between any two	$R_L = 10 \text{ k}\Omega, V_C = V_{DD}$		10			10		Ω
	switches		15			5			
THD	Total harmonic distortion	$ \begin{array}{l} V_{C} = V_{DD} = 5 \ V, \ V_{SS} = -5 \ V, \\ V_{is(p,p)} = 5 \ V \ (sine \ wave \ centered \ on \ 0 \ V), \\ R_{L} = 10 \ k\Omega, \ f_{is} = 1\text{-kHz} \ sine \ wave \end{array} $					0.4%		
	3-dB cutoff frequency (switch on)	$\label{eq:V_C} \begin{array}{l} V_C = V_{DD} = 5 \ V, \ V_{SS} = -5 \ V, \ V_{is(p\text{-}p)} = 5 \ V \\ \text{(sine wave centered on 0 V), } R_L = 1 \ k\Omega \end{array}$					40		MHz
	–50-dB feedthrough frequency (switch off)	$V_{C}$ = $V_{SS}$ = –5 V, $V_{is(p\text{-}p)}$ = 5 V (sine wave centered on 0 V), $R_{L}$ = 1 k $\Omega$					1		MHz
l <sub>is</sub>	Input/output leakage current (switch off) (max)	$V_C$ = 0 V, $V_{is}$ = 18 V, $V_{os}$ = 0 V; and $V_C$ = 0 $V_{is}$ = 0 V, $V_{os}$ = 18 V	V,	18	±0.1	±1	±10 <sup>-5</sup>	±0.1	μA
	-50-dB crosstalk frequency						8		MHz
		$R_1 = 200 \text{ k}\Omega, V_C = V_{DD}, V_{SS} = GND,$		5			20	40	
t <sub>pd</sub>	Propagation delay (signal input to signal output)	$C_L = 50 \text{ pF}, V_{is} = 10 \text{ V}$ 10					10	20	ns
		(square wave centered on 5 V), $t_r$ , $t_f$ = 20 n	15			7	15		
C <sub>is</sub>	Input capacitance	$V_{DD}$ = 5 V, $V_{C}$ = $V_{SS}$ = -5 V					8		pF
C <sub>os</sub>	Output capacitance	$V_{DD} = 5 \text{ V}, \text{ V}_{C} = \text{V}_{SS} = -5 \text{ V}$					8		pF
Cios	Feedthrough	$V_{DD} = 5 V, V_{C} = V_{SS} = -5 V$					0.5		pF



### **ELECTRICAL CHARACTERISTICS (continued)**

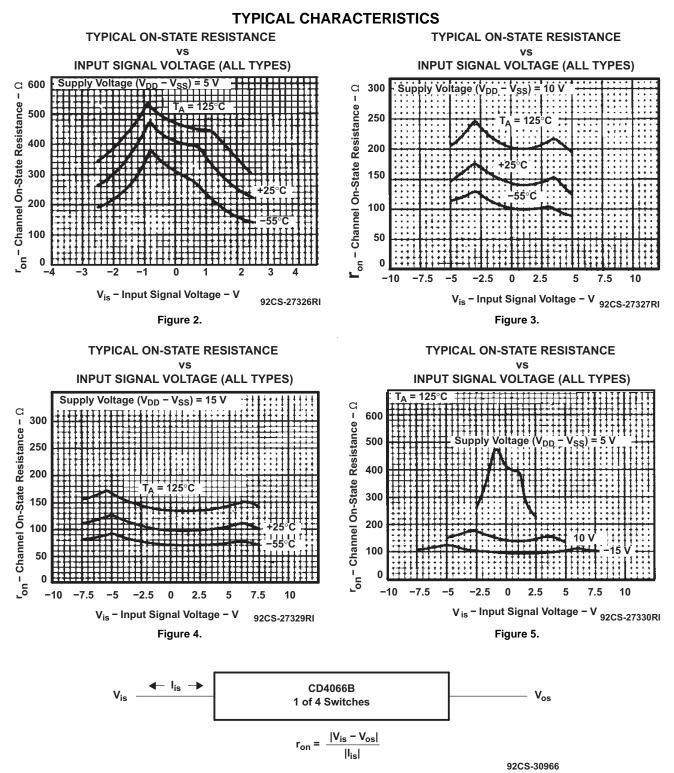
over operating free-air temperature range (unless otherwise noted)

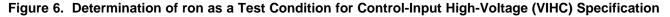
					LIMITS AT INDICATED TEMPERATURES				
	DADAMETER		V <sub>IN</sub> V <sub>DD</sub>	VDD	40%0	405%0	25°C		UNIT
PARAMETER		TEST CONDITIONS	(V)	–40°C	125°C	TYP	MAX	1	
CONT	ROL (V <sub>c</sub> )								
				5	1	1		1	
V <sub>ILC</sub>	, Control input, low voltage ⊫C (max)	$ I_{is}  < 10 \text{ mA}, V_{is} = V_{SS}, V_{OS} = V_{DD}$ , and $V_{is} = V_{DD}, V_{OS} = V_{SS}$	10	2	2		2	V	
		$v_{is} = v_{DD}, v_{OS} = v_{SS}$	15	2	2		2		
						3.5 (MIN)			
V <sub>IHC</sub> Control input, low voltage	Control input, low voltage	See Figure 6	10	7 (MIN)					
			15	11 (MIN)					
I <sub>IN</sub>	Input current (max)	$V_{is} \le V_{DD}, V_{DD} - V_{SS} = 18 \text{ V}, V_{CC} \le V_{DD} - V_{SS}$	s	18	±0.1	±1	±10 <sup>-5</sup>	±0.1	μA
	Crosstalk (control input to signal output)	$V_{C}$ = 10 V (square wave), t <sub>r</sub> , t <sub>f</sub> = 20 ns, R <sub>L</sub> = 10 k $\Omega$		10			50		mW
				5			35	70	
	Turn-on and turn-off propagation delay	$V_{IN} = V_{DD}$ , t <sub>r</sub> , t <sub>f</sub> = 20 ns, C <sub>1</sub> = 50 pF, R <sub>1</sub> = 1 k $\Omega$	$V_{IN} = V_{DD}, t_r, t_f = 20 \text{ ns},$				20	40	ns
propagation delay	propagation delay	0 = 30 pr , N = 1 M2		15			15	30	
		$V_{is} = V_{DD}$ , $V_{SS} = GND$ , $R_L = 1 \text{ k}\Omega$ to GND,	$V_{is} = V_{DD}$ , $V_{SS} = GND$ , $R_L = 1 \text{ k}\Omega$ to GND,				6		
	Maximum control input	$C_L = 50 \text{ pF}, V_C = 10 \text{ V}$ (square wave	10			9		MHz	
	repetition rate	centered on 5 V), $t_r$ , $t_f$ = 20 ns, V <sub>os</sub> = 1/2 V <sub>os</sub> at 1 kHz		15			9.5		
Ci	Input capacitance						5		pF

### SWITCHING CHARACTERISTICS

		SW		SWITCH OUTPUT, V <sub>os</sub> (V)		
V <sub>DD</sub> (V)	V <sub>is</sub>		l <sub>is</sub> (mA)			
(•)	(V)	–40°C	25°C	125°C	MIN	MAX
5	0	0.61	0.51	0.36		0.4
5	5	-0.61	-0.51	-0.36	4.6	
10	0	1.5	1.3	0.9		
10	10	-1.6	-1.3	-0.9		
15	0	4	3.4	2.4		1.5
15	15	-4	-3.4	-2.4	13.5	

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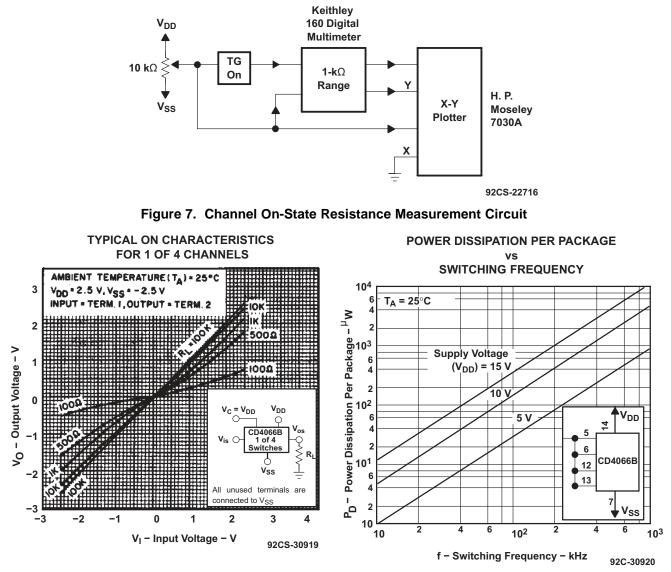


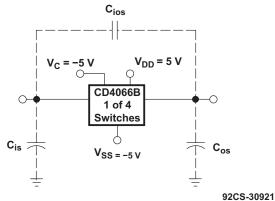
Figure 8.

Figure 9.

TEXAS INSTRUMENTS

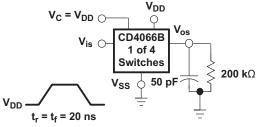
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### TYPICAL CHARACTERISTICS (continued)



Measured on Boonton capacitance bridge, model 75a (1 MHz); test-fixture capacitance nulled out.

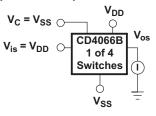
## Figure 10. Typical On Characteristics for One of Four Channels



92CS-30923

All unused terminals are connected to V<sub>SS</sub>.

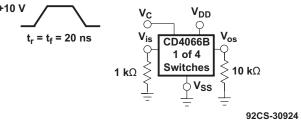
# Figure 12. Propagation Delay Time Signal Input (V\_{is}) to Signal Output (V\_{os})



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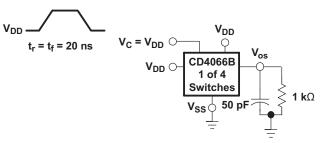
All unused terminals are connected to V<sub>SS</sub>.

Figure 11. Off-Switch Input or Output Leakage



3 All unused terminals are connected to V<sub>SS</sub>.

#### Figure 13. Crosstalk-Control Input to Signal Output



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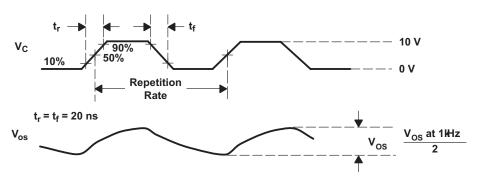
NOTES: A.All unused terminals are connected to V  $_{\rm SS}.$ 

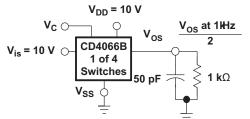
B. Delay is measured at  $V_{os}$  level of +10% from ground (turn-on) or on-state output level (turn-off).

Figure 14. Propagation Delay, t<sub>PLH</sub>, t<sub>PHL</sub> Control-Signal Output





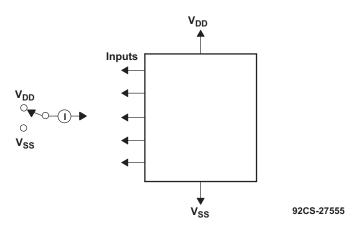




All unused terminals are connected to  $\ensuremath{\mathsf{V}_{\text{SS}}}$  .

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### Figure 15. Maximum Allowable Control-Input Repetition Rate

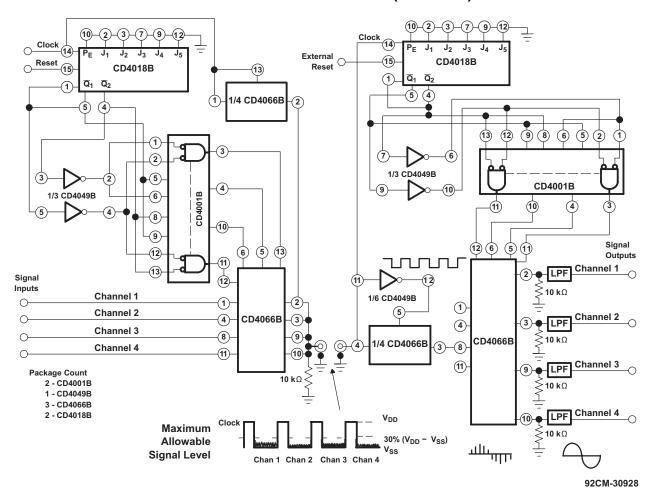


Measure inputs sequentially to both  $V_{DD}$  and  $V_{SS}$ . Connect all unused inputs to either  $V_{DD}$  or  $V_{SS}$ . Measure control inputs only.

#### Figure 16. Input Leakage-Current Test Circuit

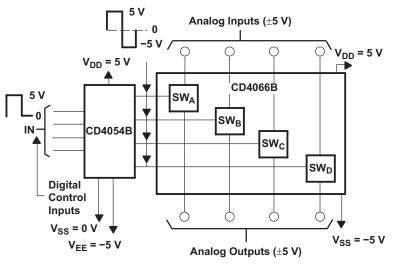
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### **TYPICAL CHARACTERISTICS (continued)**

Figure 17. Four-Channel PAM Multiplex System Diagram



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### Figure 18. Bidirectional Signal Transmission Via Digital Control Logic



### **APPLICATION INFORMATION**

In applications that employ separate power sources to drive  $V_{DD}$  and the signal inputs, the  $V_{DD}$  current capability should exceed  $V_{DD}/R_L$  ( $R_L$  = effective external load of the four CD4066B-Q1 bilateral switches). This provision avoids any permanent current flow or clamp action on the  $V_{DD}$  supply when power is applied or removed from the CD4066B-Q1.

In certain applications, the external load-resistor current can include both  $V_{DD}$  and signal-line components. To avoid drawing  $V_{DD}$  current when switch current flows into terminals 1, 4, 8, or 11, the voltage drop across the bidirectional switch must not exceed 0.8 V (calculated from  $r_{on}$  values shown).

No  $V_{DD}$  current will flow through  $R_L$  if the switch current flows into terminals 2, 3, 9, or 10.



### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
CD4066BQDRQ1	LIFEBUY	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	CD4066BQ	

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD4066B-Q1 :



• Catalog : CD4066B

• Military : CD4066B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



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